

07-24-1998



100774553

PATENT
Docket # 137024PU

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

RECORDING COVER SHEET

Jc549 U.S. PTO
09/116305
07/15/98

- 1. Assignor: Chao-Zen LIU
- 2. Assignee: SPEED TECH CORP.
3Fl., No. 492-19, Sec. 1, Wan-Shou Rd.
Kwei-Shan Hsiang, TAO-YUAN HSIEN, TAIWAN R.O.C.

- 3. Nature of Conveyance: Assignment of patent
- 4. Reference number: Application filed herewith.

- 5. Correspondence to: Keith Kline
PRO-TECHTOR INTERNATIONAL
20775 Norada Court
Saratoga, CA 95070-3018

- 6. Number of applications affected by this recording: 1
Total Fee (= # of apps x \$40.00) = \$40.00

Authorization is hereby given to charge the above to deposit account # 16-2497.

- 7. Execution date of the document to be recorded: 06/30/98
- 8. Total number of pages including cover sheet: 2

9. I declare under penalty of perjury that to the best of my knowledge and belief, the information contained on this cover sheet is true and correct, and that any copy submitted herewith is a true and correct copy of the original document.

10. CERTIFICATION OF MAILING (37 CFR 1.10): I hereby certify that this paper (along with any referred to as being attached or enclosed) is being deposited with the United States Postal Service on the date shown below with sufficient postage as Express Mail in an envelope addressed to: Box New Applications, The Assistant Commissioner for Patents, Washington, D.C. 20231.

07/23/1998 DCBATES 00000200 162497 09116305

01 FC:581 40.00 CH

Respectfully submitted,

Date: July 15, 1998



Keith Kline
PRO-TECHTOR INTERNATIONAL
20775 Norada Court
Saratoga, CA 95070-3018

Registration No: 32,737
Telephone: (408) 778-3440

ASSIGNMENT OF INVENTION

In consideration of the payment by ASSIGNEE to ASSIGNOR of the sum of One Dollar (\$1.00), the receipt of which is hereby acknowledged, and for other good and valuable consideration, ASSIGNOR

Assignor's Name	Assignor's Residence and/or Address	Nationality
(1) <u>Chao-Zen Liu</u>	<u>3Fl-1, No.492-19, Sec.1, Wan-Shou Rd., Kwei-Shan Hsiang, Tao-Yuan Hsien, Taiwan</u>	<u>TAIWAN R.O.C.</u>
(2)		
(3)		
(4)		

hereby sells, assigns and transfers to ASSIGNEE

Assignee's Name	Assignee's Residence and/or Address	Nationality
<u>SPEED TECH CORP.</u>	<u>3Fl-1, No.492-19, Sec.1, Wan-Shou Rd., Kwei-Shan Hsiang, Tao-Yuan Hsien, Taiwan</u>	<u>TAIWAN R.O.C.</u>

and the successors, assigns and legal representatives of the ASSIGNEE *[check one of the following]*
 the entire right, title, and interest an undivided _____ percent (____%) interest
 in and to any and all improvements which are disclosed in the invention entitled: Memory Module Connector
 _____, and which is found in *[check one of the following]*

- (a) U.S. patent application executed on June 30, 1998
- (b) U.S. patent application serial number _____, filed on _____
- (c) U.S. patent number _____, issued on _____

and, in and to, all Letters Patent to be obtained for said invention by the above application or any continuation, division, renewal, or substitute thereof, and as to Letters Patent any reissued or re-examination thereof.

ASSIGNOR hereby covenants that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment;

ASSIGNOR further covenants that ASSIGNOR will communicate to ASSIGNEE or its representatives any facts known to ASSIGNOR respecting the invention, to testify in any legal proceedings, to sign all lawful papers, to execute all divisions, continuations, substitutions, renewal and reissue applications, and to generally do those things necessary to aid ASSIGNEE and its successors and assigns to obtain and enforce proper protection for the invention in the United States and in any and all foreign countries.

Assignor's Signature	Printed Name and/or Title	Date Signed
(1) <u><i>Chaozen Liu</i></u>	<u>Chao-Zen Liu (engineer)</u>	<u>June 30, 1998</u>
(2)		
(3)		
(4)		